TENTATIVE

TOSHIBA PHOTOCOUPLER GaAs IRED & PHOTO-TRANSISTOR

TLP627A,TLP627A-2,TLP627A-4

TELECOMMUNICATION PROGRAMMABLE CONTROLLERS DC-OUTPUT MODULE

The TOSHIBA TLP627A, -2, and -4 consist of a gallium arsenide infrared emitting diode optically coupled to a darlington connected phototransistor which has a 350V high voltage of collector-emitter breakdown voltage.

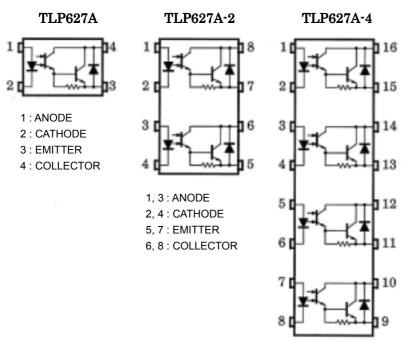
The TLP627A-2 offer two isolated channels in a eight lead plastic DIP package, while the TLP627A-4 provide four isolated channels per package.

Collector-Emitter Voltage : 350V(MIN)
 Current Transfer Ratio : 1500% (MIN)
 Isolation Voltage : 5000Vrms(MIN)

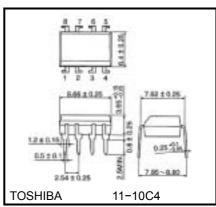
単位: mm TOSHIBA 11-5B2

Weight: 0.26 g

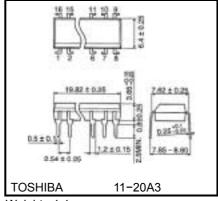
PIN CONFIGURATION (TOP VIEW)



1, 3, 5, 7 : ANODE 2, 4, 6, 8 : CATHODE 9, 11, 13, 15 : EMITTER 10, 12, 14, 16 : COLLECTOR



Weight: 0.54 g



Weight: 1.1 g

MAXIMUM RATINGS (Ta = 25°C)

| CHARACTERISTICS | | | RAT | | |
|---|---|---------------------|-----------------------------------|------------------------|--------|
| | | SYMBOL | TLP627A | TLP627A-2 TLP627A-4 | UNIT |
| | Forward Current | lF | 60 | 60 50 | |
| ۵ | Forward Current Derating | ΔI _F /°C | -0.7 (Ta≧39°C) | -0.5 (Ta≧25°C) | mA /°C |
| LED | Pulse Forward Current | I _{FP} | 1 (100 <i>μ</i> s Pu | Α | |
| | Reverse Voltage | V _R | | V | |
| | Collector-Emitter Voltage | V _{CEO} | 35 | V | |
| œ | Emitter-Collector Voltage | V _{ECO} | 0 | V | |
| CTO | Collector Current | I _C | 15 | mA | |
| DETECTOR | Collector Power Dissipation (1 circuit) | PC | 150 (300) (*) | 100 | mW |
| | Collector Power Dissipation Derating (Ta≧25°C, 1 Circuit) | ΔP _C /°C | -1.5 (-3.5) (*) | -1.0 | mA /°C |
| Sto | rage Temperature Range | T _{stg} | -55 | °C | |
| Оре | erating Temperature Range | T _{opr} | -55 | °C | |
| Lea | Lead Soldering Temperature | | 260 (1 | °C | |
| Total Package Power Dissipation (1 circuit) | | P _T | 250 (320) (*) | 150 | mW |
| Total Package Power Dissipation Derating (Ta≧25°C, 1 circuit) | | ΔP _T /°C | -2.5 (-3.2) (*) | -1.5 | mW /°C |
| Isolation Voltage | | BVS | 5000 (AC、1 min、R.H.≦60%) (**) | | Vrms |

^{* :} IF = 20 mA max

RECOMMENDED OPERATING CONDISIONS

| CHARACTERISTICS | SYMBOL | MIN. | TYP. | MAX. | UNIT |
|-----------------------|------------------|------|------|------|------|
| Supply Voltage | V _{CC} | _ | _ | 200 | V |
| Forward Current | l _F | _ | 16 | 25 | mA |
| Collector Current | IC | _ | _ | 120 | mA |
| Operating Temperature | T _{opr} | -25 | _ | 85 | °C |

INDIVIDUAL ELECTRICAL CHARACTERISTICS (Ta = 25°C)

| | CHARACTERISTICS | SYMBOL | TEST CONDITION | MIN. | TYP. | MAX. | UNIT |
|--------|-------------------------------------|------------------|------------------------------------|------|------|------|------|
| | Forward Voltage | V_{F} | I _F = 10 mA | 1.0 | 1.15 | 1.3 | V |
| LED | Reverse Current | I _R | V _R = 5 V | _ | _ | 10 | μΑ |
| | Capacitance | C _T | V = 0, f = 1 MHz | _ | 30 | _ | pF |
| | Collector-Emitter Breakdown Voltage | V (BR) CEO | I _C = 0.1 mA | 350 | 1 | _ | V |
| JOR. | Emitter-Collector Breakdown Voltage | V (BR) ECO | I _E = 0.1 mA | 0.3 | 1 | _ | V |
| DETECT | Collector Dark Current | I _{CEO} | V _{CE} = 300 V | _ | 10 | 200 | nA |
| DET | | | V _{CE} = 300 V, Ta = 85°C | - | - | 20 | μΑ |
| | Capacitance Collector to Emitter | C _{CE} | V = 0, f = 1 MHz | _ | 10 | _ | pF |

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Device considered a two terminal device : LED side pins shorted together and DETECTOR side pins shorted together.

COUPLED ELECTRICAL CHARACTERISTICS (Ta = 25°C)

| CHARACTERISTICS | SYMBOL | TEST CONDITION | MIN. | TYP. | MAX. | UNIT |
|--------------------------------------|---------------------------------------|---|------|------|------|------|
| Current Transfer Ratio | I _C / IF | I _F = 1 mA, V _{CE} = 1 V | 1500 | 4000 | _ | % |
| Saturated CTR | I _C / I _{F (sat)} | I _F = 10 mA, V _{CE} = 1 V | 500 | _ | _ | % |
| Collector-Emitter Saturation Voltage | V _{CE (sat)} | I _C = 15 mA, I _F = 1 mA | _ | _ | 1.0 | V |
| Collector-Emitter Saturation Voltage | | I _C = 100 mA, I _F = 10 mA | 0.3 | _ | 1.2 | V |

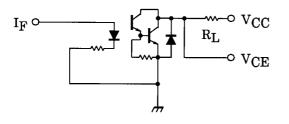
ISOLATION CHARACTERISTICS (Ta = 25°C)

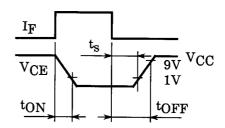
| CHARACTERISTICS | SYMBOL | TEST CONDITION | MIN. | TYP. | MAX. | UNIT |
|-----------------------------|----------------|----------------------------------|--------------------|------------------|------|--------|
| Capacitance Input to Output | CS | V _S = 0, f = 1 MHz | _ | 0.8 | _ | pF |
| Isolation Resistance | R _S | V _S = 500 V, R.H.≦60% | 5×10 ¹² | 10 ¹⁴ | _ | Ω |
| | | AC、1 minite | 5000 | _ | _ | Vrms |
| Isolation Voltage | BV_S | AC、1 second、in oil | _ | 10000 | _ | VIIIIS |
| | | DC、1 second、in oil | _ | 10000 | _ | Vdc |

SWITCHING CHARACTERISTICS (Ta = 25°C)

| CHARACTERISTICS | SYMBOL | TEST CONDITION | MIN. | TYP. | MAX. | UNIT |
|-----------------|------------------|--|------|------|------|------|
| Rise Time | t _r | | _ | 40 | _ | |
| Fall Time | t _f | V _{CC} = 10 V | _ | 15 | _ | ,,, |
| Turn-on Time | t _{on} | $I_C = 10 \text{ mA}$ $R_L = 100 \Omega$ | _ | 50 | _ | μs |
| Turn-off Time | t _{off} | | _ | 15 | _ | |
| Turn-on Time | t _{ON} | | _ | 5 | _ | |
| Strage Time | ts | $R_L = 180 \Omega$ (Fig.1) $V_{CC} = 10 \text{ V}, I_F = 16 \text{ mA}$ | _ | 40 | _ | μs |
| Turn-off Time | toff | | _ | 80 | _ | |

Fig.1: SWITCHING TIME TEST CIRCUIT





RESTRICTIONS ON PRODUCT USE

000707EBC

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